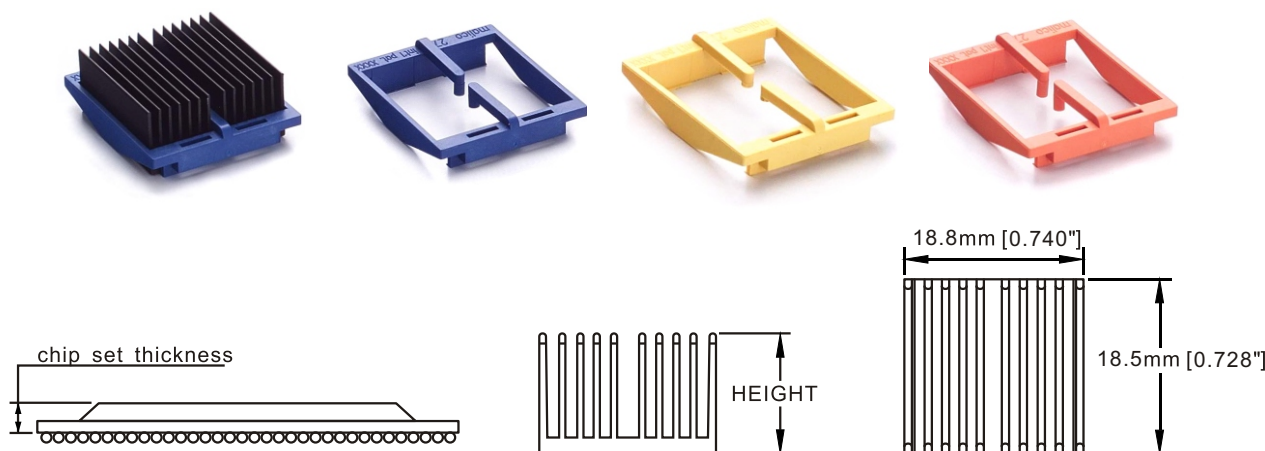


Model : CHBA311919 Series

Specification

BGA Heat Sink for 19x19 chip set



■ Heat sink material :

AL6063

■ Finish :

Black Anodize

■ Chip set package thickness and clip color :

- 2.1mm~2.6mm Yellow clip
- 1.5mm~2.0mm Blue clip
- 0.9mm~1.4mm Orange clip

■ Accessory :

- Clip material Plastic(94V0)
- Thermal pad T725 17x17mm [0.669"]

Part number	Length (mm) [Inch]	Width (mm) [Inch]	Total height (mm) [Inch]	Base (mm) [Inch]	Clip color
CHBA3119190601-00	18.8 [0.740"]	18.7 [0.736"]	6.3 [0.248"]	1.7 [0.066"]	Yellow
CHBA3119190602-00					Blue
CHBA3119190603-00					Orange
CHBA3119191001-00	18.8 [0.740"]	18.5 [0.728"]	9.5 [0.374"]	1.7 [0.066"]	Yellow
CHBA3119191002-00					Blue
CHBA3119191003-00					Orange
CHBA3119191301-00	18.8 [0.740"]	18.5 [0.728"]	12.7 [0.500"]	1.7 [0.066"]	Yellow
CHBA3119191302-00					Blue
CHBA3119191303-00					Orange

Performance

Heat Source(LxW):15x15mm

